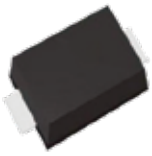
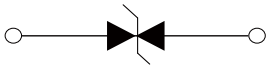
FEATURES

- Low profile package
- Ideal for automated placement
- 400 Watt peak pulse power capability with a 10/1000µs waveform
- For surface mounted applicatons to optimize board space
- Excellent clamping capability
- Very fast response time
- Low incremental surge resistance
- Meet AEC-Q101 Requirements



SOD-123FL



Schematic Symbol

APPLICATIONS

- Power supply protection
- Automotive application
- Industrial application
- Power management

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003

MAXIMUM RATINGS (T_A=25°C)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation on 10/1000µs waveform (Note1)	P_{PPM}	400	Watts
Steady State Power Dissipation at T_L=75°C	P_D	2.8	Watts

Notes : 1.Non-repetitive current pulse,T_A=25°C.
2.8.3ms single half sine-wave, or equivalent square wave, Duty cycle = 4 pulses per minutes maximum

THERMAL CONSIDERATIONS

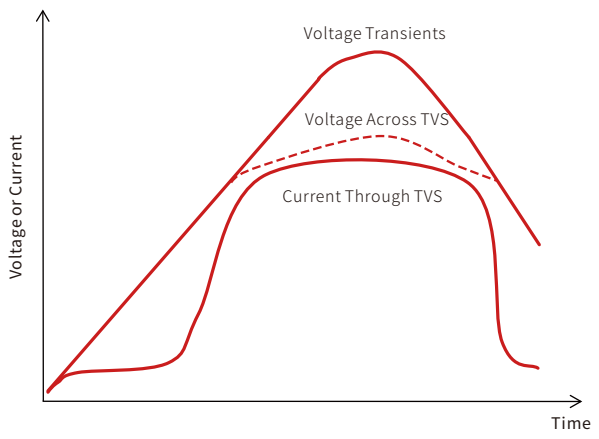
Parameter	Symbol	Value	Unit
Operating junction Temperature	T_J	-55 ~ +150	°C
Storage Temperature Range	T_S	-55 ~ +150	°C
Junction to Ambient on Printed circuit	$R_{\theta JA}$	220	°C/W

ELECTRICAL CHARACTERISTICS

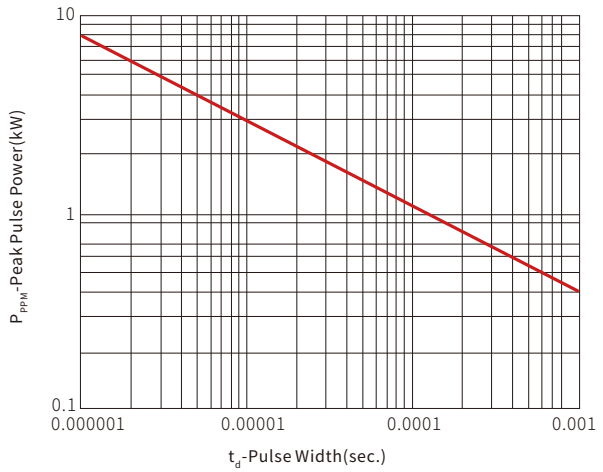
Part Number	Device Marking Code	Reverse Stand-off Voltage	Breakdown Voltage Min.@I_T	Breakdown Voltage Max.@I_T	Test Current	Maximum Clamping Voltage @I_{PP}	Maximum Peak Pulse Current	Maximum Reverse Leakage @V_{RWM}
		V_{RWM}(V)	V_{BR}(V)	V_{BR}(V)	I_T(mA)	V_C(V)	I_{PP}(A)	I_R(uA)
TPSVF40B16	XP	16.0	17.8	19.7	1.0	26.0	15.4	1.0

CHARACTERISTIC CURVES

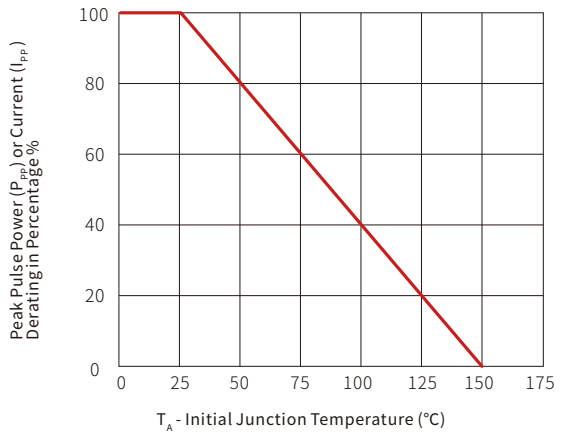
TVS Transients Clamping Waveform



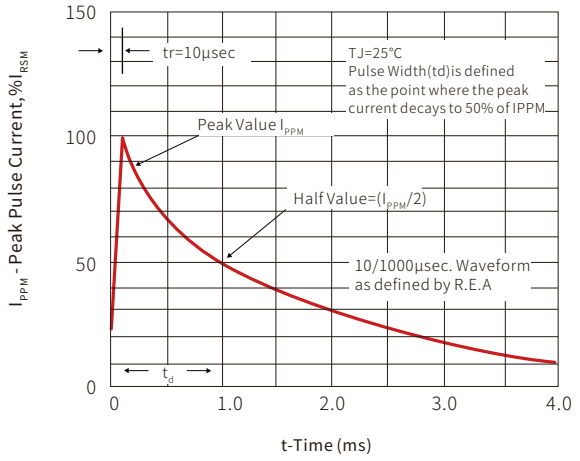
Peak Pulse Power Rating Curve



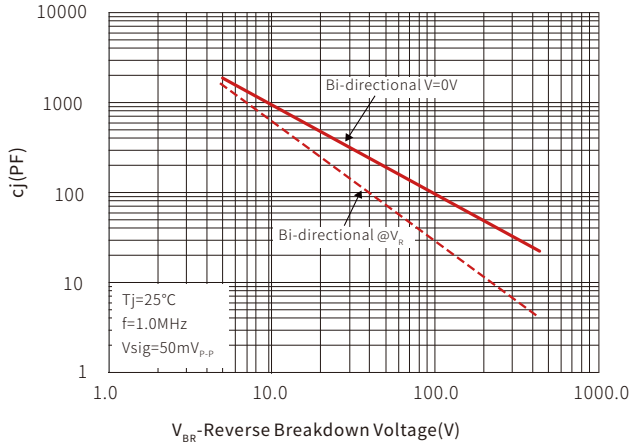
Pulse Derating Curve



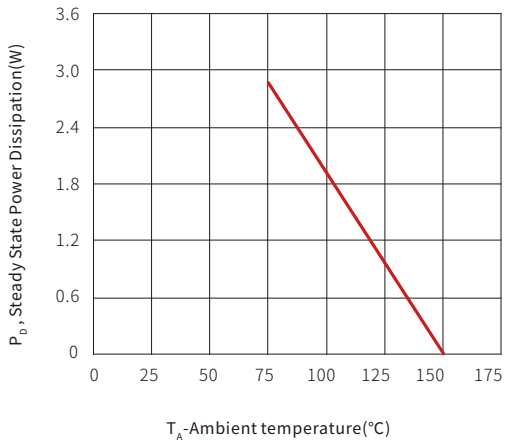
Pulse Waveform



Typical Junction Capacitance

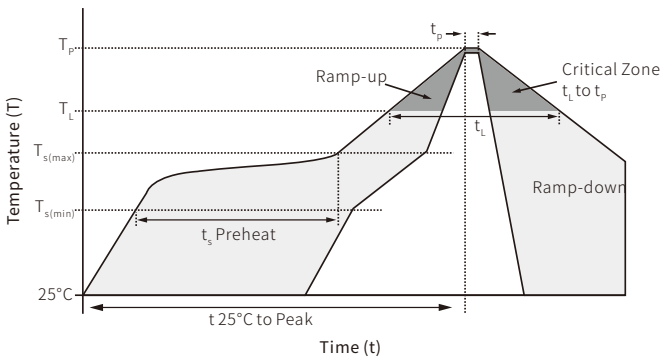


Steady State Power Dissipaton Deraiting Curve

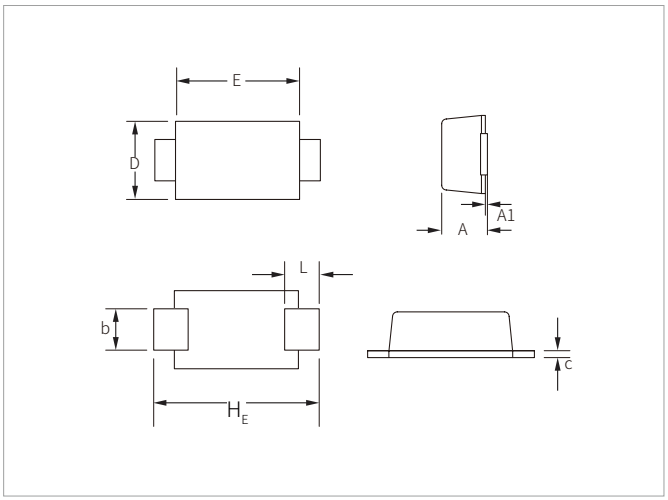


SOLDERING PARAMETERS

Reflow Condition		Lead–free assembly
Pre Heat	Temperature Max ($T_{s(min)}$)	150°C
	Temperature Max ($T_{s(max)}$)	200°C
	Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak		3°C/second max
$T_{S(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Time (min to max) (t_L)	60 – 150 seconds
Peak Temperature (T_P)		260°C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_P)		8 minutes max.
Do not exceed		260°C

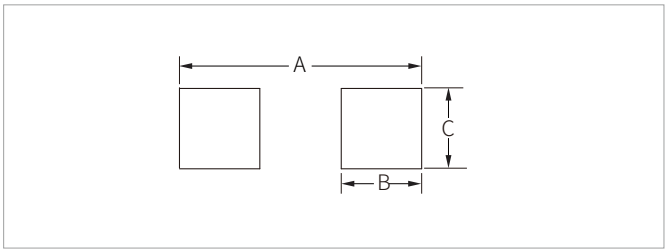


SOD-123FL PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.95	1.45	0.037	0.057
A1	0.00	0.10	0.000	0.004
b	0.70	1.20	0.028	0.047
c	0.05	0.30	0.002	0.012
D	1.50	2.00	0.059	0.079
E	2.50	3.10	0.098	0.122
L	0.35	0.90	0.014	0.035
H_E	3.40	3.90	0.134	0.154

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters	Inches
A	4.20	0.165
B	1.50	0.059
C	1.20	0.047

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
TPSVF40B16	SOD-123FL	3000PCS	7”

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